

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number: [0901522118](#)
Status: **Active**
Overview: [cgrid_sl_products](#)
Description: 2.54mm (.100") Pitch C-Grid III™ PC Board Connector, Dual Row, Right Angle, Straight PCB Pins 1.0µm (40µ") Tin (Sn), 18 Circuits

Documents:

[3D Model](#) [RoHS Certificate of Compliance \(PDF\)](#)
[Drawing \(PDF\)](#)

General

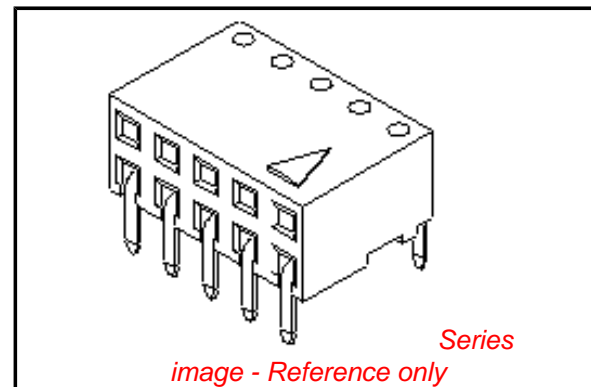
Product Family	PCB Receptacles
Series	90152
Application	Board-to-Board
Overview	cgrid_sl_products
Product Name	C-Grid III™

Physical

Circuits (Loaded)	18
Circuits (maximum)	18
Color - Resin	Black
Durability (mating cycles max)	30
Glow-Wire Compliant	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	No
Material - Metal	Phosphor Bronze
Material - Plating Mating	Tin
Material - Plating Termination	Tin
Material - Resin	Polyester
Number of Rows	2
Orientation	Right Angle
PC Tail Length (in)	0.114 In
PC Tail Length (mm)	2.90 mm
PCB Locator	No
PCB Retention	None
PCB Thickness Recommended (in)	0.063 In
PCB Thickness Recommended (mm)	1.60 mm
Packaging Type	Tube
Pitch - Mating Interface (in)	0.100 In
Pitch - Mating Interface (mm)	2.54 mm
Pitch - Term. Interface (in)	0.100 In
Pitch - Term. Interface (mm)	2.54 mm
Plating min: Mating (µin)	40
Plating min: Mating (µm)	1.00
Plating min: Termination (µin)	40
Plating min: Termination (µm)	1.00
Polarized to Mating Part	Yes
Polarized to PCB	No
Stackable	No
Surface Mount Compatible (SMC)	No
Temperature Range - Operating	-55°C to +125°C
Termination Interface: Style	Through Hole

Electrical

Current - Maximum per Contact	3A
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EU RoHS

ELV and RoHS Compliant
REACH SVHC Contains SVHC: No
Halogen-Free Status
Not Reviewed

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
 For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

[90152Series](#)

Mates With

[90122](#) , [90131](#)

Grounding to PCB
Voltage - Maximum

No
350V AC/DC

Solder Process Data

Lead-free Process Capability

Wave Capable (TH only)

Material Info

Reference - Drawing Numbers

Sales Drawing

SDA-90152

This document was generated on 05/24/2010

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TERMINAL RETENTION FEATURE



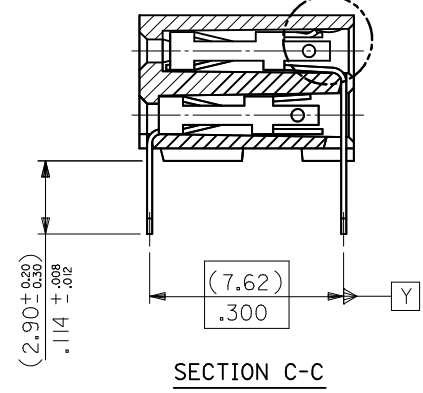
RECOMMENDED P.C. BOARD HOLE PATTERN

NOTES

- 1) CONTACT-PLATED PHOSPHOR BRONZE.
- 2) HOUSING-15% GLASS FILLED POLYESTER. COLOUR-BLACK.
- 3) COMPATABLE WITH PCB HOLE PATTERN.
- 4) THIS MARK INDICATES CIRCUIT NO.1.
- 5) FOR (0.635)/.025 SQ. MALE PINS THE LENGTH MUST BE (5.65)/.222 MIN & (7.00)/.276 MAX. TO ENSURE GOOD CONNECTION WITH CONTACT.
- 6) PRODUCT SPECIFICATION: PS-99020-0001
- 7) RECOMMENDED PCB THICKNESS 1.6MM



SEE DETAIL "A"



SECTION C-C

DETAIL "A"



TERMINAL RETENTION FEATURE

CHG PKG QTY FOR 4CKT EC NO: S2010-0556 DRW:WAT/SEE 2010/01/12 CHKD:SKANG 2010/01/14 APPR:MLONG 2010/01/14	QUALITY SYMBOLS $F_{\Delta} = 0$ $F_{\square} = 0$ $F_{\nabla} = 0$	GENERAL TOLERANCES (UNLESS SPECIFIED) mm INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± 0.20 ± .008 1 PLACE ± --- ± --- ANGULAR ± 2 °	DIMENSION STYLE MM ONLY DRAWN BY DATE DB 1987/07/14 CHECKED BY DATE DB 1987/07/14 APPROVED BY DATE MLONG 2010/01/14	SCALE NTS DESIGN UNITS METRIC THIRD ANGLE PROJECTION	TITLE C-GRID PCB CONN DR HORZ
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	MATERIAL NO. SEE TABLE	MOLEX INCORPORATED DOCUMENT NO. SDA-90152	SHEET NO. 1 OF 5	

10	9	8	7	6	5	4	3	2	1
PART NO.	CKT	DIM. A		DIM. B ^(+0.00) _(-0.30) ^{+0.00} _{-0.12}		PCS/ TUBE			
90152-XX04	4	(2.54)	.100	(5.08)	.200	109			
06	6	(5.08)	.200	(7.62)	.300	73			
08	8	(7.62)	.300	(10.16)	.400	55			
10	10	(10.16)	.400	(12.70)	.500	44			
12	12	(12.70)	.500	(15.24)	.600	36			
14	14	(15.24)	.600	(17.78)	.700	31			
16	16	(17.78)	.700	(20.32)	.800	27			
18	18	(20.32)	.800	(22.86)	.900	24			
20	20	(22.86)	.900	(25.40)	1.000	22			
22	22					20			
24	24	(27.94)	1.100	(30.48)	1.200	18			
26	26	(30.48)	1.200	(33.02)	1.300	16			
28	28					14			
30	30	(35.56)	1.400	(38.10)	1.500	14			
32	32					13			
34	34	(40.64)	1.600	(43.18)	1.700	12			
36	36	(43.18)	1.700	(45.72)	1.800	12			
38	38	(45.72)	1.800	(48.26)	1.900	11			
40	40	(48.26)	1.900	(50.80)	2.000	11			
42	42					10			
44	44	(53.34)	2.100	(55.88)	2.200	10			
46	46					10			
48	48					9			
50	50	(60.96)	2.400	(63.50)	2.500	8			
52	52					8			
54	54					8			
56	56	(68.58)	2.700	(71.12)	2.800	7			
58	58					7			
60	60	(73.66)	2.900	(76.20)	3.000	7			
62	62					6			
90152-XX64	64	(78.74)	3.100	(81.28)	3.200	5			

PLATING VERSION A

PRE-PLATED HOT DIP TIN
1.0 TO 2.5 microns (.00004" TO .00010").

PLATING VERSION E

1.27 TO 1.78 microns (.00005" TO .00007") NICKEL
OVERALL, 0.38 TO 0.64 microns (.000015" TO .000025")
GOLD ON CONTACT AREA (OVER NICKEL).
3 TO 5 microns (.00012" TO .00020") TIN
ON SOLDER TAILS (OVER NICKEL).

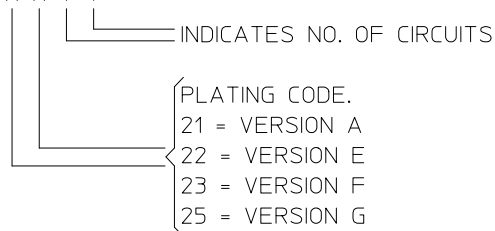
PLATING VERSION F

1.27 TO 1.78 microns (.00005" TO .00007") NICKEL
OVERALL, 0.76 TO 1.0 microns (.00003" TO .00004")
GOLD ON CONTACT AREA (OVER NICKEL).
3 TO 5 microns (.00012" TO .00020") TIN
ON SOLDER TAILS (OVER NICKEL).

PLATING VERSION G

1.27 TO 1.78 microns (.00005" TO .00007") NICKEL
OVERALL, 0.125 TO 0.20 microns (.000005" TO .0000079")
GOLD ON CONTACT AREA (OVER NICKEL).
3 TO 5 microns (.00012" TO .00020") TIN
ON SOLDER TAILS (OVER NICKEL).

90152 - X X Y Y



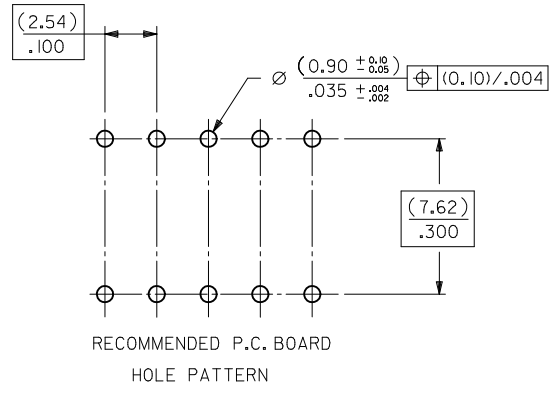
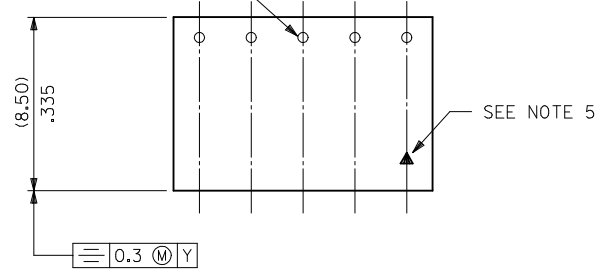
STANDARD PRODUCTS

CHG PKG QTY FOR 4CKT EC NO: S2010-0556 DRWN:ATSEE 2010/01/12 CHKD:SKANG 2010/01/14 APPR:MLONG 2010/01/14	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION															
	$\nabla_A = 0$ $\nabla_C = 0$ $\nabla_P = 0$	<table border="1"> <tr><th colspan="2">mm</th><th>INCH</th></tr> <tr><td>4 PLACES</td><td>± ---</td><td>± ---</td></tr> <tr><td>3 PLACES</td><td>± ---</td><td>± ---</td></tr> <tr><td>2 PLACES</td><td>± 0.20</td><td>± .008</td></tr> <tr><td>1 PLACE</td><td>± ---</td><td>± ---</td></tr> </table>	mm		INCH	4 PLACES	± ---	± ---	3 PLACES	± ---	± ---	2 PLACES	± 0.20	± .008	1 PLACE	± ---	± ---	MM ONLY	NTS	METRIC	
	mm		INCH																		
	4 PLACES	± ---	± ---																		
3 PLACES	± ---	± ---																			
2 PLACES	± 0.20	± .008																			
1 PLACE	± ---	± ---																			
DESCRIPTION	ANGULAR ± 2 °	DRAWN BY	DATE	TITLE																	
REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	DB	1987/07/14	C-GRID PCB CONN DR HORZ																	
		CHECKED BY	DATE	MOLEX INCORPORATED																	
		APPROVED BY	DATE	SDA-90152																	
		MLONG	2010/01/14	2 OF 5																	
		MATERIAL NO.	SEE TABLE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION																	

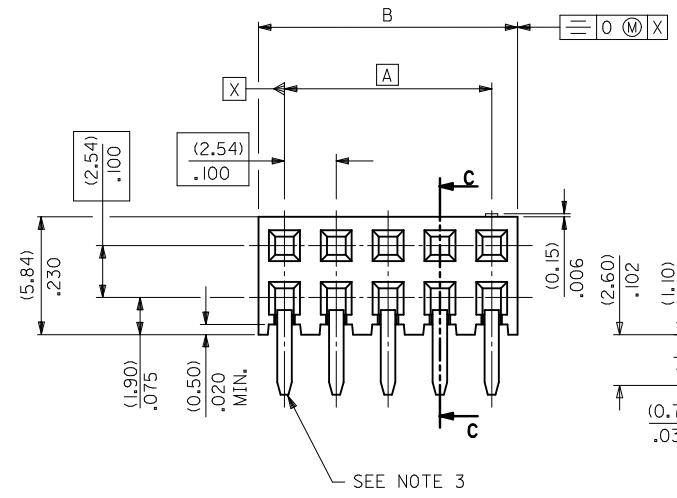


10 9 8 7 6 5 4 3 2 1

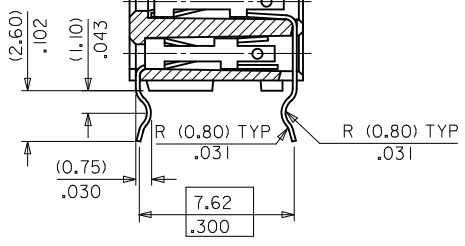
TERMINAL RETENTION FEATURE



RECOMMENDED P.C. BOARD HOLE PATTERN



(0 M) X

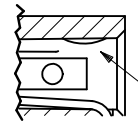


SECTION C-C

NOTES

- 1) CONTACT-PLATED PHOSPHOR BRONZE.
- 2) HOUSING-15% GLASS FILLED POLYESTER, COLOUR-BLACK.
- 3) COMPATIBLE WITH PCB HOLE PATTERN.
- 4) RECOMMENDED PC BOARD THICKNESS (1.4 ± .2) / .055 ± .008
- 5) THIS MARK INDICATES CIRCUIT NO. I.
- 6) FOR (0.635) / .025 SO. MALE PINS THE LENGTH MUST BE (5.65) / .222 MIN & (7.00) / .276 MAX. TO ENSURE GOOD CONNECTION WITH CONTACT.

DETAIL *A*



TERMINAL RETENTION FEATURE

CHG PKG QTY FOR 4CKT EC NO: S2010-0556 DRWNAT/SEE 2010/01/12 CHKD/SKANG 2010/01/14 APPR/MLONG 2010/01/14	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
	$\nabla=0$ $\nabla=0$ $\nabla=0$	4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± .20 ± .008 1 PLACE ± --- ± ---	MM ONLY	NTS	METRIC	
	DESCRIPTION	ANGULAR ± 2°	DRAWN BY	DATE	TITLE	C-GRID PCB CONN DR HORZ
	MATERIAL NO. DRAWN BY CHECKED BY APPROVED BY DATE	SEE TABLE DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	DB	1987/07/14	MOLEX INCORPORATED SDA-90152	

MLONG DATE 2010/01/14	TITLE C-GRID PCB CONN DR HORZ
MATERIAL NO. DATE 2010/01/14	TITLE C-GRID PCB CONN DR HORZ
MATERIAL NO. DATE 2010/01/14	TITLE C-GRID PCB CONN DR HORZ

TITLE C-GRID PCB CONN DR HORZ	TITLE C-GRID PCB CONN DR HORZ
MOLEX INCORPORATED SDA-90152	MOLEX INCORPORATED SDA-90152
DOCUMENT NO. SDA-90152	SHEET NO. 3 OF 5

9 8 7 6 5 4 3 2 1

	10	9	8	7	6	5	4	3	2	1
	PART NO.	CKT	DIM. A		DIM. B ^(+0.00) _(-0.30) ^{+0.00} _{-0.12}		PCS/ TUBE			
F	90152-XX04	4	(2.54)	.100	(5.08)	.200	109			
	06	6	(5.08)	.200	(7.62)	.300	73			
	08	8	(7.62)	.300	(10.16)	.400	55			
	10	10	(10.16)	.400	(12.70)	.500	44			
	12	12	(12.70)	.500	(15.24)	.600	36			
	14	14	(15.24)	.600	(17.78)	.700	31			
	16	16	(17.78)	.700	(20.32)	.800	27			
	18	18	(20.32)	.800	(22.86)	.900	24			
E	20	20	(22.86)	.900	(25.40)	1.000	22			
	22	22					20			
	24	24	(27.94)	1.100	(30.48)	1.200	18			
	26	26	(30.48)	1.200	(33.02)	1.300	16			
	28	28					14			
	30	30	(35.56)	1.400	(38.10)	1.500	14			
	32	32					13			
	34	34	(40.64)	1.600	(43.18)	1.700	12			
D	36	36	(43.18)	1.700	(45.72)	1.800	12			
	38	38	(45.72)	1.800	(48.26)	1.900	11			
	40	40	(48.26)	1.900	(50.80)	2.000	11			
	42	42					10			
	44	44	(53.34)	2.100	(55.88)	2.200	10			
	46	46					10			
	48	48					9			
	50	50	(60.96)	2.400	(63.50)	2.500	8			
C	52	52					8			
	54	54					8			
	56	56	(68.58)	2.700	(71.12)	2.800	7			
	58	58					7			
	60	60	(73.66)	2.900	(76.20)	3.000	7			
	62	62					6			
B	90152-XX64	64	(78.74)	3.100	(81.28)	3.200	5			

PLATING VERSION A

PRE-PLATED HOT DIP TIN
1.0 TO 2.5 microns (.00004" TO .00010").

PLATING VERSION E

1.27 TO 1.78 microns (.00005" TO .00007") NICKEL
OVERALL, 0.38 TO 0.64 microns (.000015" TO .000025")
GOLD ON CONTACT AREA (OVER NICKEL).
3 TO 5 microns (.00012" TO .00020") TIN
ON SOLDER TAILS (OVER NICKEL).

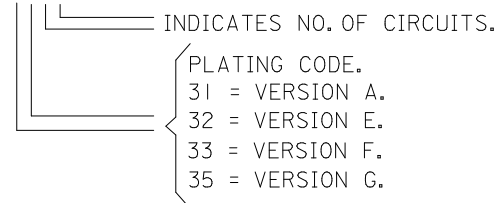
PLATING VERSION F.

1.27 TO 1.78 microns (.00005" TO .00007") NICKEL
OVERALL, 0.76 TO 1.0 microns (.00003" TO .00004")
GOLD ON CONTACT AREA (OVER NICKEL).
3 TO 5 microns (.00012" TO .00020") TIN
ON SOLDER TAILS (OVER NICKEL).

PLATING VERSION G.

1.27 TO 1.78 microns (.00005" TO .00007") NICKEL
OVERALL, 0.125 TO 0.20 microns (.000005" TO .0000079")
GOLD ON CONTACT AREA (OVER NICKEL).
3 TO 5 microns (.00012" TO .00020") TIN
ON SOLDER TAILS (OVER NICKEL).

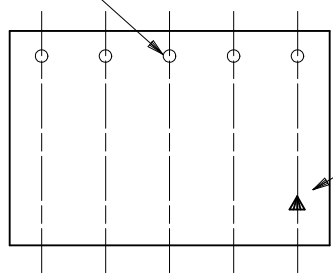
90152-XXYY



A	CHG PKG QTY FOR 4CKT EC NO: S2010-0556 DRWN:ATSEE 2010/01/12 CHKD:SKANG 2010/01/14 APPR:MLONG 2010/01/14	REV DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
			$\nabla_A=0$	mm INCH	MM ONLY	NTS	METRIC	
			$\nabla_C=0$	4 PLACES ± --- ± ---	DRAWN BY DATE			C-GRID PCB CONN DR HORZ
			$\nabla_P=0$	3 PLACES ± --- ± ---	DB 1987/07/14			
	2 PLACES ± 0.20 ± .008	CHECKED BY DATE			MOLEX INCORPORATED			
	1 PLACE ± --- ± ---	DB 1987/07/14						
	ANGULAR ± 2 °	APPROVED BY DATE			SDA-90152			
		MLONG 2010/01/14						
		MATERIAL NO.			DOCUMENT NO.	SHEET NO.		
		SEE TABLE				4 OF 5		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS						
		SIZE A3						

PART NUMBER	CKT. SIZE	PIN VOID	KINKED PINS	NO. PER TUBE
90152-6234	2 X 17	21	NONE	12
90152-5242	2 X 21	5	NONE	10
90152-7130	2 X 15	NONE	1,2 & 29,30	14

TERMINAL RETENTION FEATURE



SEE NOTE 2.

NOTES

- 1) FOR DIMENSIONS SEE SHEET 1.
- 2) THIS MARK INDICATES CIRCUIT NO.1.
- 3) SOLDER TAIL OF TERMINAL IN VOIDED CAVITY MUST BE CROPPED AS SHOWN OR TERMINAL REMOVED.

90152-XXYY

INDICATES NO. OF CIRCUITS.
 PLATING CODE.
 1 = VERSION A.
 2 = VERSION E.
 3 = VERSION F.
 5 = VERSION G.

OPTIONS
 2 = REGULAR
 3 = KINKED
 5 = VOIDS
 6 = KINKS & VOIDS
 7 = SELECTIVE KINKS

SEE DETAIL "A"



SECTION C-C

DETAIL "A"



TERMINAL RETENTION FEATURE

CHG PKG QTY FOR 4CKT EC NO: S2010-0556 DRWN:ATSEE 2010/01/12 CHKD:SKANG 2010/01/14 APPR:MLONG 2010/01/14	DESCRIPTION REV	QUALITY SYMBOLS $F_A=0$ $F_C=0$ $F_P=0$	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE NTS	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION				
		4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± 0.20 ± .008 1 PLACE ± --- ± --- ANGULAR ± 2°	mm INCH ± --- ± --- ± 0.20 ± .008 ± --- ± ---	DRAWN BY DB	DATE 1987/07/14	TITLE C-GRID PCB CONN DR HORZ							
				CHECKED BY DB	DATE 1987/07/14	APPROVED BY MLONG					DATE 2010/01/14	MOLEX INCORPORATED	
				MATERIAL NO. SEE TABLE		DOCUMENT NO. SDA-90152		SHEET NO. 5 OF 5		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			

SEE CHART
SDA-90152

PART NO.	NO. OF CKTS.	DIM. A		DIM. B $\begin{matrix} (+0.00 \\ -0.30 \\ +.000 \\ -.012 \end{matrix}$		NO. PER TUBE
90152-XX04	4	(2.54)	.100	(5.08)	.200	110
▲ ▲ 06	6	(5.08)	.200	(7.62)	.300	73
08	8	(7.62)	.300	(10.16)	.400	55
10	10	(10.16)	.400	(12.70)	.500	44
12	12	(12.70)	.500	(15.24)	.600	36
14	14	(15.24)	.600	(17.78)	.700	31
16	16	(17.78)	.700	(20.32)	.800	27
18	18	(20.32)	.800	(22.86)	.900	24
20	20	(22.86)	.900	(25.40)	1.000	22
22	22					20
24	24	(27.94)	1.100	(30.48)	1.200	18
26	26	(30.48)	1.200	(33.02)	1.300	16
28	28					14
30	30	(35.56)	1.400	(38.10)	1.500	14
32	32					13
34	34	(40.64)	1.600	(43.18)	1.700	12
36	36	(43.18)	1.700	(45.72)	1.800	12
38	38	(45.72)	1.800	(48.26)	1.900	11
40	40	(48.26)	1.900	(50.80)	2.000	11
42	42					10
44	44	(53.34)	2.100	(55.88)	2.200	10
46	46					10
48	48					9
50	50	(60.96)	2.400	(63.50)	2.500	8
52	52					8
54	54					8
56	56	(68.58)	2.700	(71.12)	2.800	7
58	58					7
60	60	(73.66)	2.900	(76.20)	3.000	7
▼ ▼ 62	62					6
90152-XX64	64	(78.74)	3.100	(81.28)	3.200	5

PLATING VERSION A

PRE-PLATED HOT DIP TIN
1.0 TO 2.5 microns (.00004" TO .00010").

PLATING VERSION E

1.27 TO 1.78 microns (.00005" TO .00007") NICKEL
OVERALL, 0.38 TO 0.64 microns (.000015" TO .000025")
GOLD ON CONTACT AREA (OVER NICKEL).
3 TO 5 microns (.00012" TO .00020") TIN
ON SOLDER TAILS (OVER NICKEL).

PLATING VERSION F.

1.27 TO 1.78 microns (.00005" TO .00007") NICKEL
OVERALL, 0.76 TO 1.0 microns (.00003" TO .00004")
GOLD ON CONTACT AREA (OVER NICKEL).
3 TO 5 microns (.00012" TO .00020") TIN
ON SOLDER TAILS (OVER NICKEL).

PLATING VERSION G.

1.27 TO 1.78 microns (.00005" TO .00007") NICKEL
OVERALL, 0.125 TO 0.20 microns (.000005" TO .0000079")
GOLD ON CONTACT AREA (OVER NICKEL).
3 TO 5 microns (.00012" TO .00020") TIN
ON SOLDER TAILS (OVER NICKEL).

90152-XXYY

INDICATES NO. OF CIRCUITS.

PLATING CODE.
21 = VERSION A.
22 = VERSION E.
23 = VERSION F.
25 = VERSION G.

STANDARD PRODUCTS

FOR PREVIOUS
DRAWING ISSUES
SEE MRI.

LEAD FREE CONVERSION
NEW BORDER ADDED
EC NO. E2004-0610
DRWN: PSHEAHAN 08/01/2004
CHK:
APPR:
AD

QUALITY SYMBOLS
MAJOR
CRITICAL
REV DESCRIPTION

GENERAL TOLERANCES:
(UNLESS SPECIFIED)
mm INCH
4 PLACES ±0. ±.
3 PLACES ±0. ±.
2 PLACES ±0. ±.
1 PLACE ±0. ±.
ANGULAR: ± °
DRAFT WHERE APPLICABLE MUST
REMAIN WITHIN DIMENSIONS

SCALE 5:1
DESIGN UNITS mm INCH
DRAWN BY & DATE DB 14/ 7/87
CHECKED BY & DATE
APPROVED BY & DATE
CAD FILENAME s90152x2 DGN

DIMENSIONS: mm INCH mm INCH ONLY
SHT REV
REVISION ON CAD ONLY
TITLE: C-GRID III
DUAL ROW HORIZONTAL
P.C. BOARD CONNECTOR
moLEX MOLEX INCORPORATED
MATERIAL NO. SEE CHART
DRAWING NO. SDA-90152
SHEET NO. 20F
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.
SIZE B